## Electronic Version v1.1

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SUBMISSION TYPE:		NEW ASSIGNMENT			
NATURE OF CONVEYANCE:			ASSIGNMENT		
CONVEYING PARTY DATA					
N			Name Execution Date		
Chia-Hui Chen				08/29/2007	
RECEIVING PARTY DATA					
Name:	Taiwan Semiconductor Manufacturing Company, Limited.				
Street Address:	No.8 Li-Hsin Road 6, Science Based Industrial Park				
City:	Hsin-Chu				
State/Country:					
Postal Code:	300-77				
PROPERTY NUMBERS Total: 1					
Property Type			Number		
Application Number: 118		11850	0667		066
Application Number: 11850667   CORRESPONDENCE DATA Augusta Statement of Stateme					
Fax Number:(415)882-8107Correspondence will be sent via US Mail when the fax attempt is unsuccessful.Phone:415-882-8200					
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ATTORNEY DOCKET NUMBER:			1152604-00225		
NAME OF SUBMITTER:			Howard Chen, Esq.		
Total Attachments: 2 source=115260400225assignment#page1.tif source=115260400225assignment#page2.tif					

Patent Attorney Docket No.: TSMC2001-0183

Attorney Reference No.: 52604-00225

## ASSIGNMENT AND AGREEMENT

For value received, I/we Chia-Hui Chen, hereby equally sell, assign and transfer to Taiwan Semiconductor Manufacturing Co., Ltd., with its principal place of business located at No. 8, Li-Hsin Road 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, Republic of China, and their successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to HIGH VOLTAGE TOLERANT INPUT BUFFER described in U.S. Application Number 11/850,667 for Letters Patent of the United States filed on September 5th , 2007 and all the rights and privileges in said application and under any and all Letters Patent and any divisions, continuations, continuations-in-part, reexamination certificates, reissues, and extensions thereof that may be granted in the United States for said inventions; and I/we also concurrently hereby sell, assign and transfer to Taiwan Semiconductor Manufacturing Co., Ltd. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

I/We authorize Taiwan Semiconductor Manufacturing Co., Ltd. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from me/us, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

I/We hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of **Taiwan Semiconductor Manufacturing Co.**, Ltd. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

I/We request that any and all patents for said inventions be issued to **Taiwan Semiconductor Manufacturing Co., Ltd.** in the United States and in all countries foreign to the United States, or to such nominees as **Taiwan Semiconductor Manufacturing Co., Ltd.** may designate.

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Patent Attorney Docket No.: TSMC2007-0183

Attorney Reference No.: 52604-00225

I/We agree that, when requested, I/we shall, without charge to **Taiwan Semiconductor Manufacturing Co., Ltd.** but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

**Inventor No. 1:** 

. . . •

Dated: 2007/08/29

Chia-Hui Chen

## Chia-Hui Chen

Mailing and Residence: 11-F-2, No. 333, Sec. 1, Guangfu Road, East District, Hsinchu City 300, Taiwan (R.O.C.)

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PATENT REEL: 019799 FRAME: 0708

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